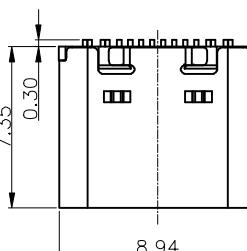
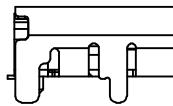


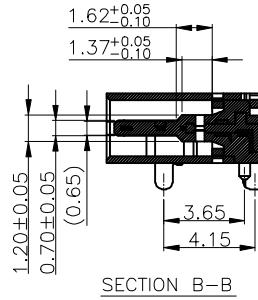
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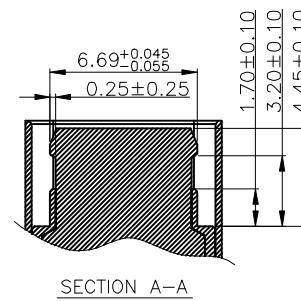
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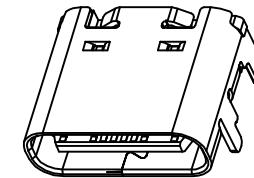
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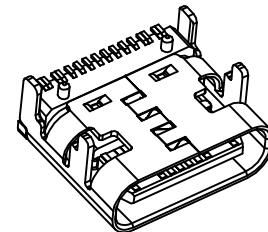
C



B



A



1

2

3

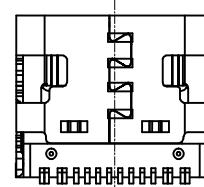
4

1

2

3

4



SPECIFICATION:

1. Material:
HOUSING&MOLDING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0
CONTACTS:COPPER ALLOY T=0.20mm
MIDDLE CLIP:SUS301-1/2H,T=0.15mm
SHELL:COPPER ALLOY,T=0.30mm

2. Mechanical:

- 2.1.Mating force:5~20Nf Max.;
- 2.2.Unmating force:6~20Nf Min.;
- 2.3.Durability:10000 Cycles;

3.Electrical:

- 3.1.Current Rating:3A Max.;
- 3.2.Voltage Rating:20V Max.;
- 3.3.Dielectric Withstanding voltage:100VAc;
- 3.4.Contact resistance:40m Ohms Max.;
- 3.5.Insulation Resistance:100M Ohms Min.;

4.Environmental:

- 4.1.Operating temperature:-40°C~+85°C;
- 4.2.Wetting Temperature:265±5°C,5±0.5s

HAOFU ELECTRONICS TECHNOLOGY CO.,LTD

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PART NAME		CONNECTOR			DRAWING	Y.C.ZHANG	DWG.No.	SBCL
PART NO.		TYPE-C 2.0 16PIN SMT-3			CHECK	G.C.Chen	REV.	A1
UNIT :	mm	TOLERANCE	UP TO 5 ABOVE 5 ~30 ABOVE 30 ANGLE	±0.2 ±0.3 ±0.5 ±3°	ANGLE	APPROVAL	DATE	14-03-2013
		OTHERWISE			0°±3°	SCALE	2:1	PAGE
F	E	D	C	B	A			

东莞市皓富电子科技有限公司

产品规格书

制訂日期：17/06/10

文件編號：

文件履历表

No.	Date	Document No.	Prepared	Checked	Approved	Summary

Product specification 产品规格书

Product Name	Part Number.	Rev.
USB3.1 C TYPE CONNECTOR,	/	A

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- 1; SCOPE (适用范围)
 - 2; REFERENCE DOCUMENTS (参考文件)
 - 3; FEATURE & DIMENSIONS (特征及尺寸)
 - 3.1. PRODUCT DIMENSION (产品尺寸)
 - 3.2. PCB/PANEL LAYOUT (印刷电路板布局)
 - 3.3. MATERIAL (材料)
 - 3.4. MECHANICAL & ELECTRICAL CHARACTERISTIC (机械及电气特性)
 - 3.5. PACKAGING (包装)
 - 3.6. TRANSPORTATION (运输)
 - 3.7. STORAGE (存贮)
 4. ENVIRONMENTAL (环境要求)
 - 4.1. SOLDERABILITY (可焊性)
 - 4.2. RESISTANCE TO SOLDER HEAT (耐焊接热)
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 - 4.2.2.2. Soldering (焊接)
 - 4.2.2.3. Cool Down (冷却)
 - 4.3. CLEANING (清洗)
 5. PERFORMANCE AND TEST DESCRIPTION (性能及测试)
 - 5.1. REQUIREMENT (要求)
 - 5.2. TEST CONDITION (测试条件)
 - 5.3. SAMPLE SELECTION (样品选择)
 - 5.4. TEST SEQUENCE (测试顺序)
 6. QUALITY ASSURANCE PROVISIONS (品质保证)
- TABLE I: PRODUCT QUALIFICATION TEST SEQUENCE
- TABLE II: REFLOW SOLDERING PROFILE

1. SCOPE (适用范围)

This product specification specifies the characteristics and test methods of USB 3.1 series "C type" connectors designed and produced by haofu .

本规格书规定了由皓富设计生产的 **USB 3.1 系列“C 型”连接器**产品的特性及测试方法.

2. REFERENCE DOCUMENTS (参考文件)

MIL-STD-1344A Test method for electrical connector (电子连接器测试方法)

MIL-STD-202F Test method for electrical components (电子零件测试方法)

EIA364 Test method for electrical components (电子零件测试方法)

JIS C 0051 Test method for electrical components (电子零件测试方法)

MIL-G-45204C Specification for gold plating (镀金规格)

IEC-512-3 IEC standard for current carrying capacity tests (IEC电流测试标准)

QQ-N-290A Specification for nickel plating (镀镍规格)

MIL-P-81728A Specification for tin/lead plating (镀锡铅规格)

MIL-T-10727B Specification for tin plating (镀锡规格)

UL498 UL standard for safety of attachment plug and receptacle (UL安规要求标准)

EN/ISO5961 Determination of total lead & cadmium content (总铅和总镉含量测定)

EN1122 Determination of total lead & cadmium content (总铅和总镉含量测定)

EN13346 Determination of heavy metals content (重金属含量测定)

EPA3052 Determination of total lead & cadmium content (总铅和总镉含量测定)

3. FEATURE & DIMENSIONS (特征及尺寸)

3.1. PRODUCT DIMENSION (产品尺寸)

These connectors shall have the dimensions as shown in customer drawing。

本产品的相关尺寸参见客户图面。

3.2. PCB/PANEL LAYOUT (印刷电路板布局)

The recommended PCB layout is shown in customer drawing。

本产品适用的PCB layout参见客户图面。

3.3. MATERIAL (材料)

The harmful material can follow the requirement of RoHS.

本产品使用的材料符合 RoHS 指令要求。

3.4. MECHANICAL & ELECTRICAL CHARACTERISTIC (机械及电气特性)

The connector shall have the mechanical and electrical performance as described in table I:

本产品的机械及电气特性见附表I。

3.5. PACKAGING (包装)

This product adopts tray or REEL package

本产品采用tray 盘或REEL包装，

3.6.TRANSPORTATION (运输)

Any vehicle can be adopted for the transportation, but moisture-proof and no mechanical damage.

可采用任何运输工具运输，勿淋湿及机械性损伤。

3.7.STORAGE (存贮)

Temperature: -25°C~+85°C, Relative humidity: ≤80%, Not to storage in corrosive environments A re-qualification test shall be conducted immediately while the storage duration exceed 6 months.

温度：-25°C~+85°C；相对湿度：≤80%；勿贮存于腐蚀环境内。贮存期超过6个月后需重新进行品质确认。

4. ENVIRONMENTAL (环境要求)

4.1. SOLDERABILITY (可焊性)

Connector's solderability can meet MIL-STD-202F standard. Finish shall be free of contaminants.

产品可焊性符合 MIL-STD-202F 标准规定的相关要求，表面不得有污染物。

4.2. RESISTANCE TO SOLDER HEAT (耐焊接热)

4.2.1. Wave Soldering (波峰焊)

Consists of three consecutive phases. 包括三个连续的阶段完成；

4.2.1.1. Preheat (预热)

Increase in temperature not to exceed 4°C per second. Final preheat temperature will be within 125 °C of solder temperature. 温度增加不超过4°C /秒，最终预热温度不超过125°C。

4.2.1.2. Soldering (焊接)

Device leads will be exposed to solder wave at 250°C for a maximum of 5 seconds. 设备中的引导焊接温度最高250°C不超过5秒。

4.2.1.3. Cool Down (冷却)

Cool down in ambient air at approximately 20°C to 25°C. 冷却到周围环境温度20°C~ 25°C。

4.2.2. INFRARED REFLOW (红外线回流焊)

Three cycles. Each cycle consisting of three consecutive phased. 三个周期，每个周期包括三个连续的阶段完成；

4.2.2.1. Preheat (预热)

Increase in temperature not to exceed 4°C per second. 温度增加不超过4°C /秒，

4.2.2.2. Soldering (焊接)

Maximum allowable time above reflow temperature of 183 °C is 90 seconds. Maximum temperature in this interval is 250°C, not to exceed 10 seconds. 回流焊温度183°C以上的时最长不超过 90秒。最高温度250°C时间不超过10秒。

4.2.2.3. Cool Down (冷却)

Cool down shall not exceed 6°C per second. 冷却速度不超过6°C/秒. Note: (注) Device temperature measurements are referenced from the top-center of the package outer surface. 设备温度量测时以从顶部中间位置测量为准；

4.3. CLEANING (清洗)

Connectors resist to cleaning process. Aqueous Cleaning: Three cycles; each cycle consisting of a

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maximum of one minute exposure to 54°C to 66°C dematerialized tap water at a maximum pressure of 30 psi; followed by air drying for 60°C to 90 seconds at 93°C to 121°C.

产品本身可以承受清洗制程。 水洗：包含三个循环，每个循环包括以下：以最大压力30帕，温度 54°C~66°C，去除矿物质的水，用水龙头冲洗最多一分钟，然后用温度 93°C~121°C的空气吹60到90秒；

5. PERFORMANCE AND TEST DESCRIPTION （性能及测试）

5.1. REQUIREMENT (要求)

Product is designed to meet electrical, mechanical, and environmental performance requirements specified in **Table I**.

本产品设计符合附表一所列的机械，电气及环境要求。

5.2. TEST CONDITION (测试条件)

Unless otherwise specified, all tests shall be performed at ambient environmental conditions. 除非特别注明，所有测试在室温条件下完成；

5.3. SAMPLE SELECTION (样品选择)

Test samples shall be selected at random from current production. No test samples shall be reused.

Samples are pre-conditioned with 10cycles of durability. Each group shall be containing 5 test samples.

测试样品从现生产的产品中随机抽取，所有测试过的样品不得重复使用。样品已预先插拔10次，每组测试有5个样品；

6. QUALITY ASSURANCE PROVISIONS (品质保证)

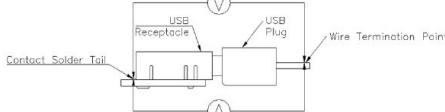
The company is responsible for the quality of all products sent to customers, and the defective batches are returned or corrected by the supplier

本公司对于出给客户的所有产品品质负责，不良批次的产品退回或由供应商做矫正；

TABLE I: PERFORMANCE REQUIREMENTS

Items	Requirements	Test Methods
1 Confirmation of Product 产品确认	Product shall be conforming to the requirements of applicable product drawing 产品必须满足相关文件的规定	Visually dimensions and functionally inspected per applicable product drawing. 目视尺寸及功能依照客户图面检查

Electrical Requirement

Items	Requirements	Test Methods
2 Low level Contact resistance 低电平接触阻抗	1. 40 mΩ (Max) initial for VBUS, GND and all other contacts. 2. Maximum change (delta) of +10 mΩ after environmental stresses. 1.电源 PIN、接地 PIN 及其它 PIN 脚接触阻抗均为 40mΩ 最大。 2.产品阻抗变化值不超过 10mΩ。 	The low level contact resistance measurement is made from the solder tail of the receptacle to the soldering point of the plug. when measured at 20mV Max. open circuit at 100mA. Mated test contacts must be in a connector housing. Test reference standard: EIA-364-23B 接触阻抗测量方式从母头的焊脚处至公头的焊脚处。 在开路最大电流为 100mA 电压为 20mV 情况下测试胶芯插入时端子之间接触处的阻抗值。 测试参考标准: EIA 364-23B
3 Insulation Resistance 绝缘阻抗	100 MΩ Min. 100 MΩ 最小	Test between adjacent circuits Insulation Resistance of unmated and mated connectors. Test reference standard: EIA 364-21. 测试对插的连接器两个相邻端子之间的绝缘阻抗值。 测试参考标准: EIA 364-21
4 Dielectric Strength 耐电压	No breakdown shall occur. 产品不能出现衰竭、损坏现象。	when 100 Volts AC (RMS) is applied between adjacent contacts of unmated and mated connectors. Test reference standard: EIA-364-20. 使用 100V 交流电压测试公母头插入与拔出时相邻端子之间的承受电压情况。 测试参考标准: EIA 364-20

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5	Contact current rating 温升	<p>1.A current of 3.0 A shall be applied collectively to VBUS pins (pins A4, A9, B4, and B9)</p> <p>2.1.25 A applied to the VCONN pin (B5 of the plug connector) with the return path through the corresponding GND pins (pins A1, A12, B1, and B12).</p> <p>3. A minimum current of 0.25 A shall also be applied individually to all the other contacts.</p> <p>1.VBUS pins 需通过电流3.0A(pin A4, A9, B4, and B9)。</p> <p>2. VCONN pin(公头B5 pin)及GND pins需通过电流1.25A(pins A1, A12, B1, and B12)。</p> <p>3.其余pins需通过最小电流0.25A。</p>	<p>When the currents are applied to the contacts, the temperature rise shall not exceed 30 °C at any point on the USB Type-C mated plug and receptacle under test, when measured at an ambient temperature of 25 °C.</p> <p>Test reference standard: EIA -364-70 method B 在相对温度为25°C，当电流通过USB C type公母头连接器时，测试连接器中端子任一点温度不超过+30°C。 测试参考标准： EIA 364-70 方法B</p>
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Mechanical Requirement

Items		Requirements	Test Methods
6	Insertion Force 插入力	<p>The initial connector insertion force shall be within the range from 5 N to 20 N. 连接器初始插入力需在 5N~20N 范围内。</p>	<p>Measure the force required to mate connector, At a maximum rate of 12.5mm(0.492") per minute. Test reference standard: EIA-364-13 测试的力必须是相匹配的连接器，插入速度不超过每分钟 12.5mm。 测试参考标准： EIA 364-13</p>
7	Extraction Force 拔出力	<p>The initial connector Extraction force shall be within the range from 6 N to 20 N. 连接器初始拔出力需在 6N~20N 范围内。</p>	<p>Measure the force required to mate connector, At a maximum rate of 12.5mm(0.492") per minute. Test reference standard: EIA-364-13 测试的力必须是相匹配的连接器，拔出速度不超过每分钟 12.5mm。 测试参考标准： EIA 364-13</p>
8	Durability or Insertion/extraction Cycles 耐久或插入拔出次数	<p>The durability rating shall be 5,000 cycles. 耐久测试 5000 次。</p>	<p>The durability test shall be done at a maximum rate of 200 cycles per Hour and no physical damage to any part of the connector and cable assembly shall occur. Test reference standard:EIA-364-09 耐久测试速度不超过每小时 200 个循环，且测试后的產品及线材本身任何部位不能出現损坏。 测试参考标准： EIA 364-09</p>

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9	Physical Shock 物理冲击	No breakdown shall occur. 产品不能出现损坏现象。	No discontinuities of 1μs or Longer duration. when mated USB C type connectors are subjected to 11ms duration 30Gs half-sine shock pluses. Three shocks in each direction applied along three mutually perpendicular planes for a total of 18 shocks. Test reference standard: EIA 364-27 Test Condition H. 匹配USB C TYPE 连接器，中断不得大于或等于1μs，30Gs的半波脉冲承受11ms，从三个正交的方向施加冲击，总冲击次数为18次。
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Environmental Requirements

Items		Requirements	Test Methods
10	Humidity 恒温恒湿	Shall meet visual requirements, show no physical damage. Contact Resistance (Low Level) 40 mΩ max. Dielectric Strength should be OK, Insulation Resistance should be 100 MΩ min. 产品外观良好，无损坏。接触阻抗：40 mΩ 最大；耐电压测试OK，绝缘阻抗100MΩ 最小。	Temperature: 25~65°C, Relative humidity: 90-95%, Duration: 96Hours, Circulate test: 10 Cycles. Test reference standard: EIA 364-31 温度：25~65°C，相对湿度：90-95%，持续时间：96 小时，循环测试：10次 测试参考标准：EIA 364-31。
11	Thermal shock 冷热冲击	Shall meet visual requirements, show no physical damage. Contact Resistance (Low Level) 40 mΩ max. Dielectric Strength should be OK, Insulation Resistance should be 100 MΩ min. 产品外观良好，无损坏。接触阻抗：40 mΩ 最大；耐电压测试OK，绝缘阻抗100MΩ 最小。	Temperature range from -55°C to +85°C .Start from -55°C. After 30 min. change to +85°C, change time is no more than 30 seconds. Total 5 cycles. Test reference standard: EIA 364-32 温度变化范围：-55°C ~ +85°C，从-55°C开始，30分钟后换到+85°C；转换时间不超过30秒；共5 个循环。 测试参考标准：EIA 364-32
12	Hot air reflow or IR reflow for SMT curing process SMT 热风回流焊	More than 95% of the dipped surface shall be wet with solder 超过95%的焊接面积浸到锡。	Place subjected connector on the PCB Board and expose them to the reflow oven and apply the following condition: Room 1: preheat temperature 150°C - 170°C for 100 seconds. Room 2: preheat temperature 170°C - 200°C for 100 seconds. Room 3: reflow temperature 200°C - 260°C for 120-60 seconds.

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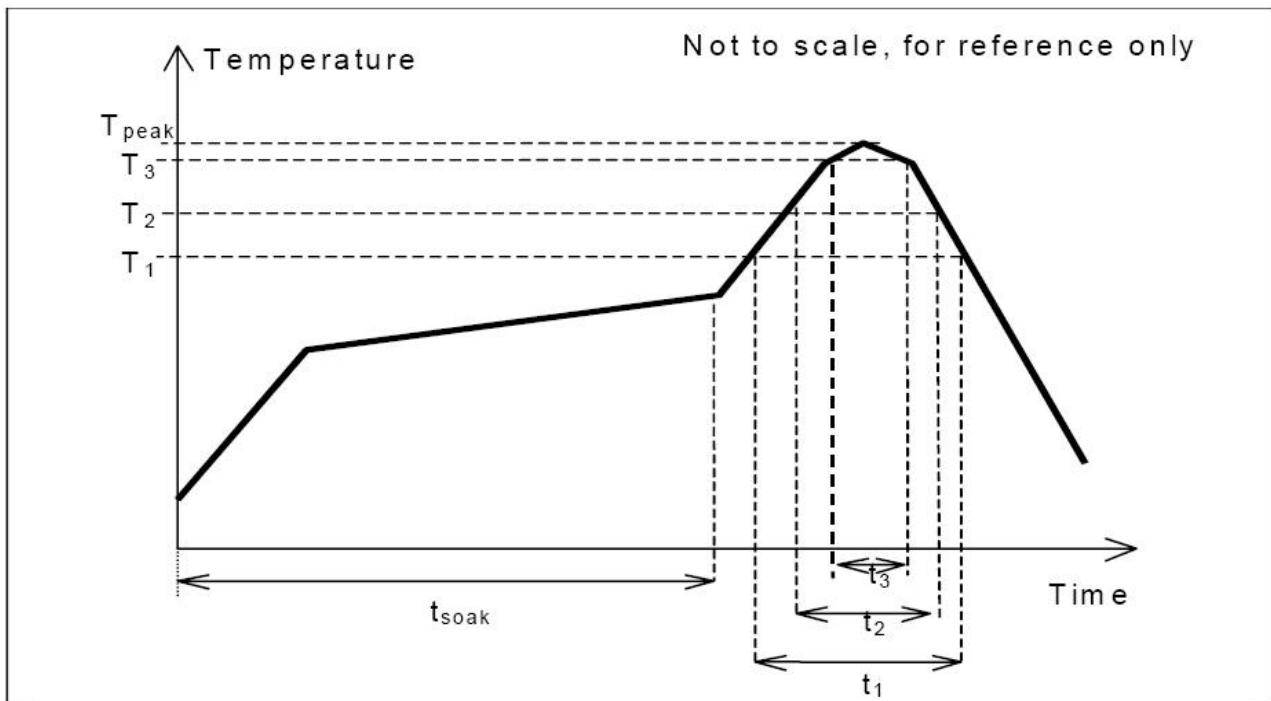
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			(For 260°C ONLY 5-10 seconds) 将产品放在PCB板上,然后放入回焊炉中并用于以下条件： 时间段1：预热温度150°C -170°C 100秒。 时间段2：预热温度170°C - 200°C 100秒。 时间段3：回焊炉温度200°C - 260 °C 100秒。(260°C 时间仅5~10S)
13	Solderability 可焊性	The inspected area of each lead must have 95% solder coverage Minimum. 检测焊接端的锡覆盖率需大于95%	Solder pot temperature: 250±5°C Soldering time: 3 to 5 Seconds Test reference standard: EIA 364-52 锡炉温度：250±5°C， 焊接时间： 3~5 秒 测试参考标准：EIA 364-52。
14	Salt Spray 盐雾测试	Shall meet visual requirements, No detrimental corrosion allowed in contact area and base metal exposed. 产品外观良好，端子及外壳金属无生锈、腐蚀及露底材不良。	Subject mated connectors to 35+/- 2 °C and 5+/-1% salt condition for 24 hours. After test, rinse the sample with water and recondition the room temperature for 1 hour. Test reference standard:EIA-364-26B. 测试的连接器需放于温度35± 2°C，盐水浓度(重量比)5±1%的容 器中测试24小时。测试后的产品使 用清水冲洗后放入常温下1小时。 测试参考标准： EIA 364-26。

TABLE II:
REFLOW SOLDERING PROFILE

Pb-free reflow profile requirements:

Parameter	Reference	Specification
Average temperature gradient in preheating		2.5°C/s
Soak time	T soak	2-3 minutes
Time above 217°C	t1	60 s
Time above 230°C	t2	50 s
Time above 250°C	t3	5 s
Peak temperature in reflow	T peak	260°C (+/-5°C)
Temperature gradient in cooling		Max -5°C/s



This profile is the minimum requirement for evaluating soldering heat resistance of components. Heat transfer method used for reflow soldering is hot air convection. The actual air temperatures used to achieve the specified profile is higher and largely dependent on the reflow equipment.

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产品功能测试报告 Product Function Test Report

委托单位 Client	品质部	委托日期 Commission	2020.11.19	测试单位 Tester	实验室	测试日期 Test Date:	2020.11.19	报告编号 Serial	HFSYS20201121001
产品品名 Part name	TYPE-C 2.0 16PIN SMT-3		样品数量 Sample Qty'		1PCS	<input type="checkbox"/> 样品描述 sample describing	<input type="checkbox"/> 新产品验证 New product validation	<input checked="" type="checkbox"/> 日常验证 Daily verification	
测试项目 Test Item	<input type="checkbox"/> 接触阻抗 LLCR	<input type="checkbox"/> 耐电压 DWV	<input type="checkbox"/> 冷热冲击 Thermal Shock	<input type="checkbox"/> 盐水喷雾 Salt Spray	<input checked="" type="checkbox"/> 耐久性测试 Durability	<input checked="" type="checkbox"/> 插拔力 Mating force&Unmating force			
	<input type="checkbox"/> 沾锡测试 Solder ability	<input type="checkbox"/> 高温测试 Temperature life	<input type="checkbox"/> 保持力 Retention Force	<input type="checkbox"/> 恒温恒湿 Humidity	<input type="checkbox"/> 绝缘电阻 InsulationResistance	<input type="checkbox"/> 其它测试 Other test			

测试过程及测试方法 The test process and test methods:

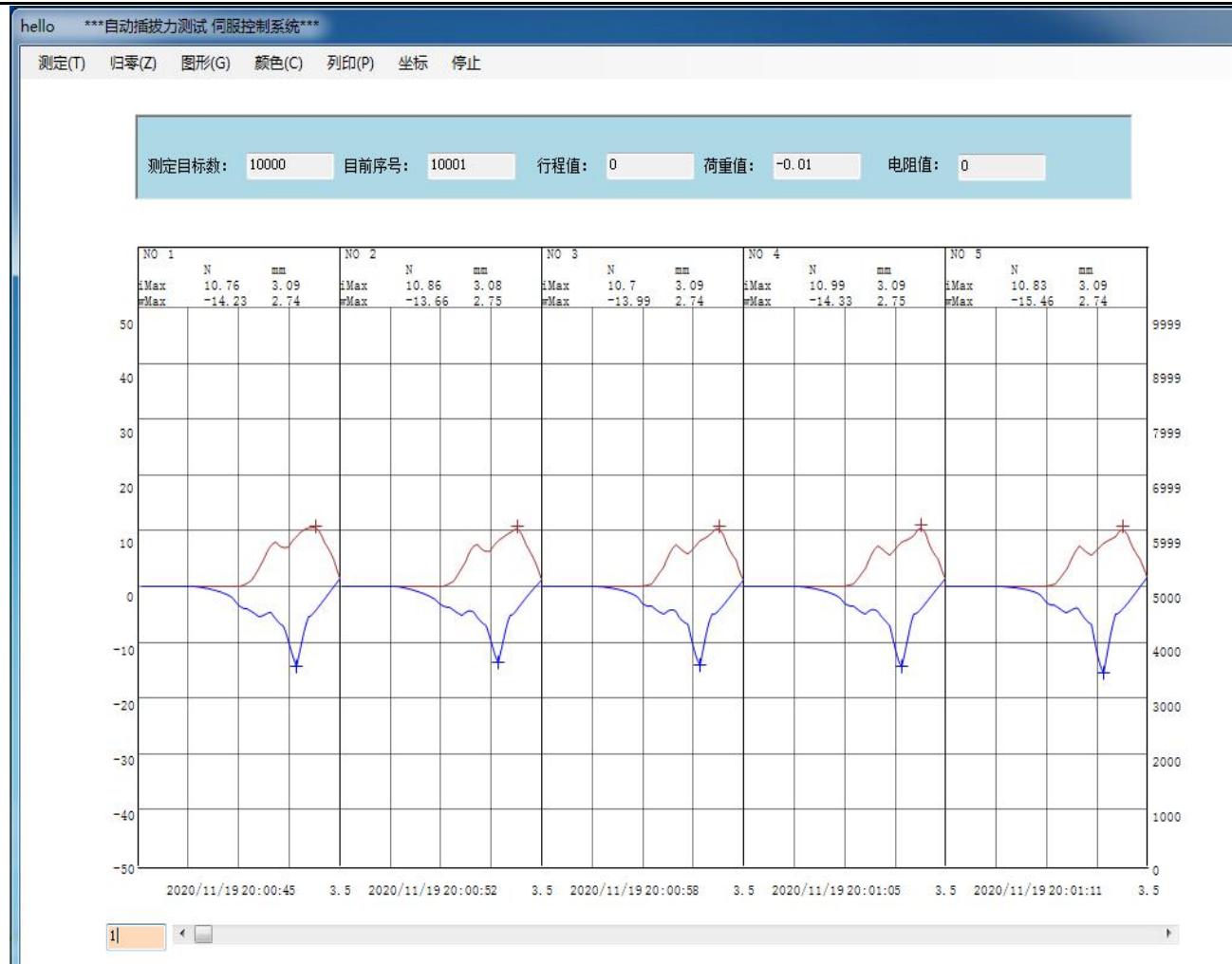
测试仪器 Test Instrument	型号/规格 Type/specification	全自动插拔试验机			计量有效期 Measure the term of validity		2021/10/30												
测试环境 TestEnvironment	温度 Temperature	23℃	湿度 Humidity	50%	测试依据 Test Standard		工程图面												
测试项目及方法 The test items and methods	插拔力测	以12.5mm/min 速度插拔32次																	
	耐久测试	以500次/H 测试10000次																	
测试结果 Test Result	列出测试/实验过程中所获得的数据资料或观察到的现象，数据资料以平均值表示 List the data materials or phenomenon that observe tested / obtained in the experiment course, the data materials are expressed with average																		
测试项目 Test Item	测定值/现象 Test Value/Phenomenon (单位unit: N)																		
初始插拔		1	2	3	4	5	最大值 Maximum	最小值 Minimum	平均值 Avg	规格 Specificati	判定 Judge								
	插入力	10.76	10.86	10.70	10.99	10.83	10.99	10.70	10.83	5-20 N	OK								
	拔出力	14.23	13.66	13.99	14.33	15.46	15.46	13.66	14.40	8-20 N	OK								
耐久测试		1000	3000	5000	7000	9000	最大值 Maximum	最小值 Minimum	平均值 Avg	规格 Specificati	判定 Judge								
	插入力	11.22	11.47	11.10	10.98	10.74	10.76	11.47	10.74	11.06	5-20 N	OK							
	拔出力	11.40	10.82	10.02	10.03	9.53	9.52	11.40	9.52	10.28	6-20 N	OK							
10000次 耐久后插拔		1	2	3	4	5	最大值 Maximum	最小值 Minimum	平均值 Avg	规格 Specificati	判定 Judge								
	插入力	8.66	8.80	8.99	8.90	8.96	8.99	8.66	8.85	5-20 N	OK								
	拔出力	8.30	8.58	8.69	8.80	8.89	8.89	8.30	8.64	6-20 N	OK								
10000次耐久后电性OK																			
Approved By:杨小华			Checked By:/			Test By: 韦凤													

东莞市皓富电子科技有限公司

产品功能测试报告 Product Function Test Report

测试项目 Test Item	<input type="checkbox"/> 接触阻抗 LLCR	<input type="checkbox"/> 耐电压 DWV	<input type="checkbox"/> 冷热冲击 Thermal Shock	<input type="checkbox"/> 盐水喷雾 Salt Spray	<input checked="" type="checkbox"/> 耐久性测试 Durability	<input checked="" type="checkbox"/> 插拔力 Mating force&Unmating force
	<input type="checkbox"/> 沾锡测试 Solder ability	<input type="checkbox"/> 高温测试 Temperature life	<input type="checkbox"/> 保持力 Retention Force	<input type="checkbox"/> 恒温恒湿 Humidity	<input type="checkbox"/> 绝缘电阻 InsulationResistance	<input type="checkbox"/> 其它测试 Other test

初始插拔曲线图



Approved By: 杨小华

Checked By:/

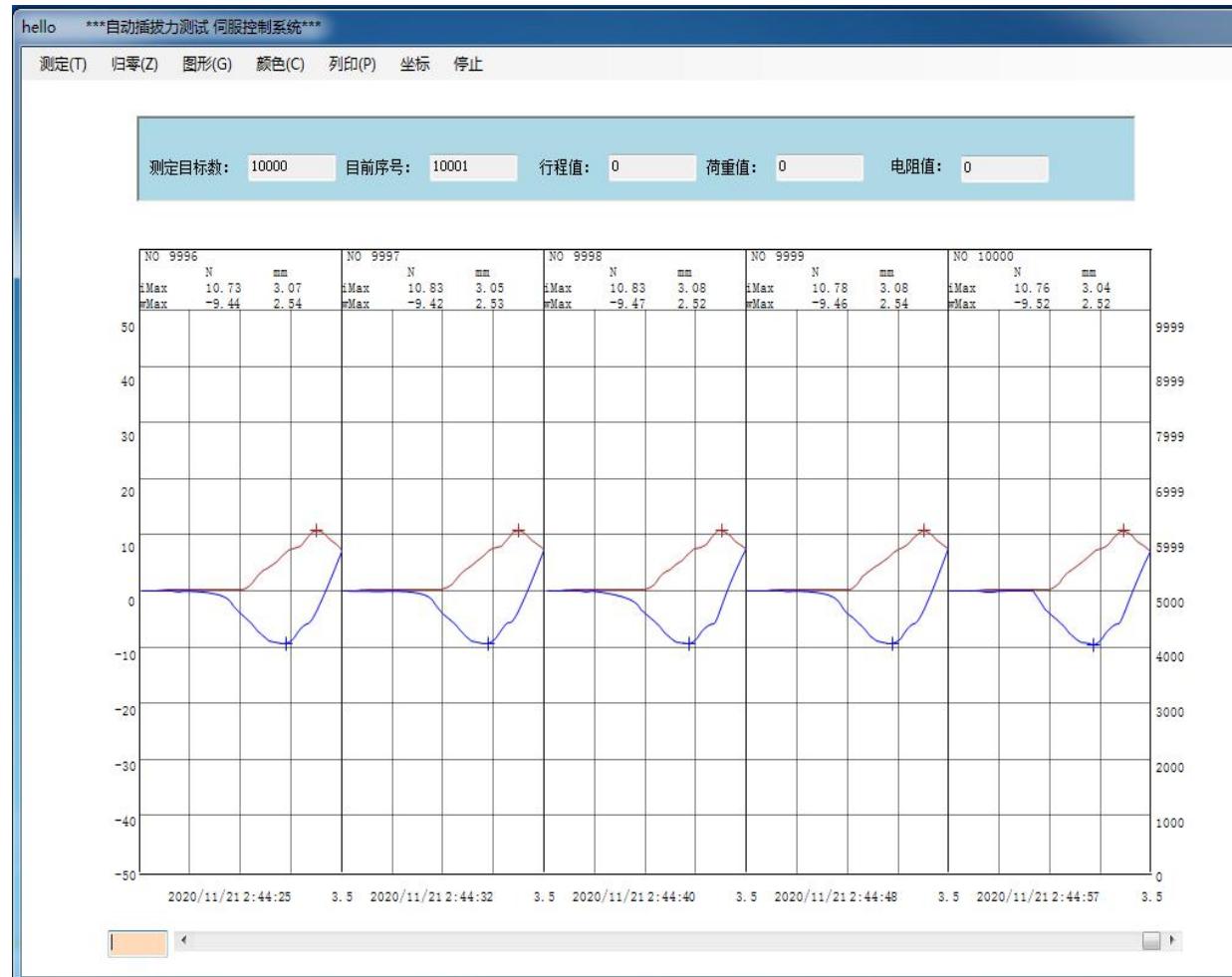
Test By: 韦凤

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耐久插拔曲线图



Approved By: 杨小华

Checked By:/

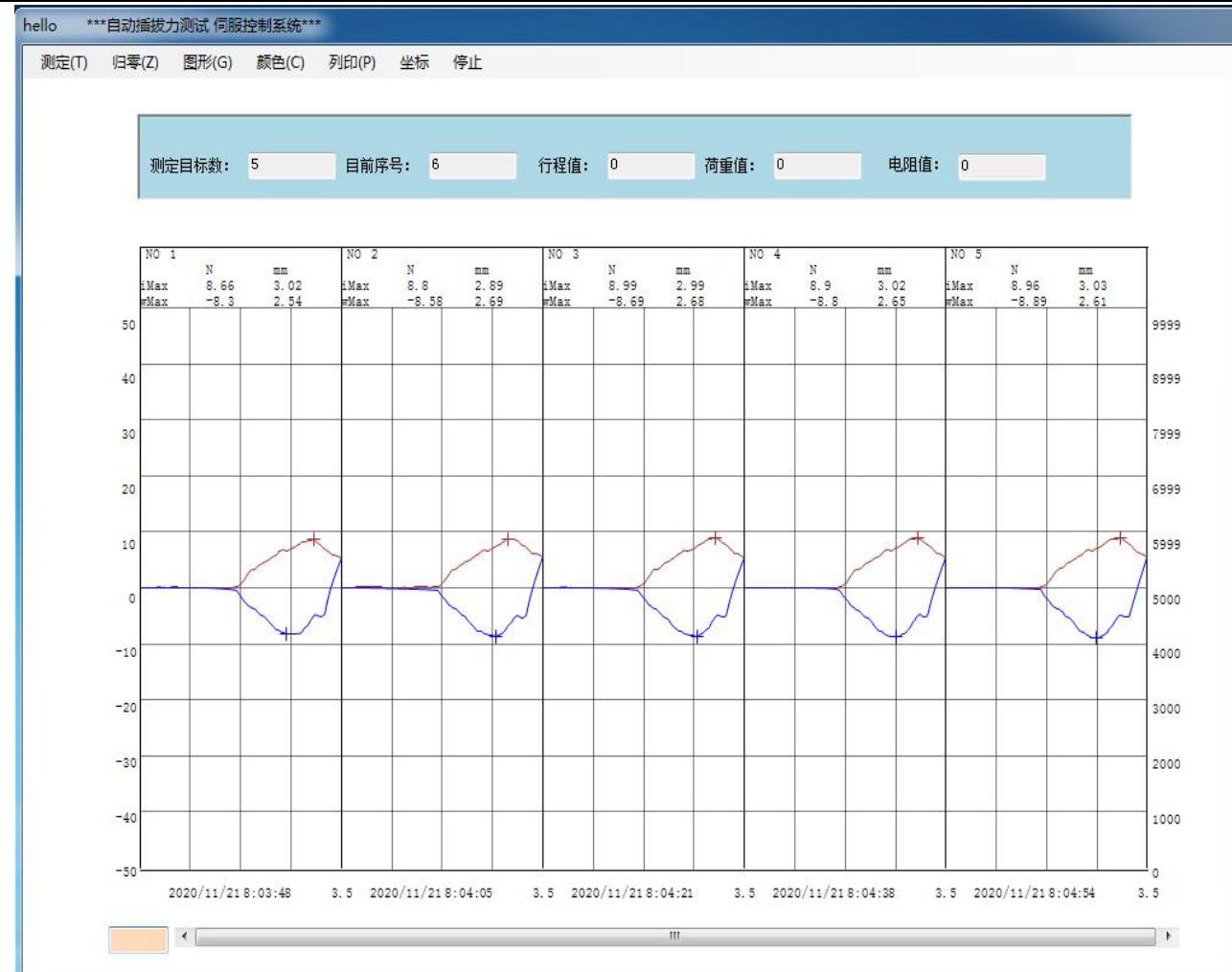
Test By: 韦凤

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10000次耐久后插拔曲线图



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Checked By:/

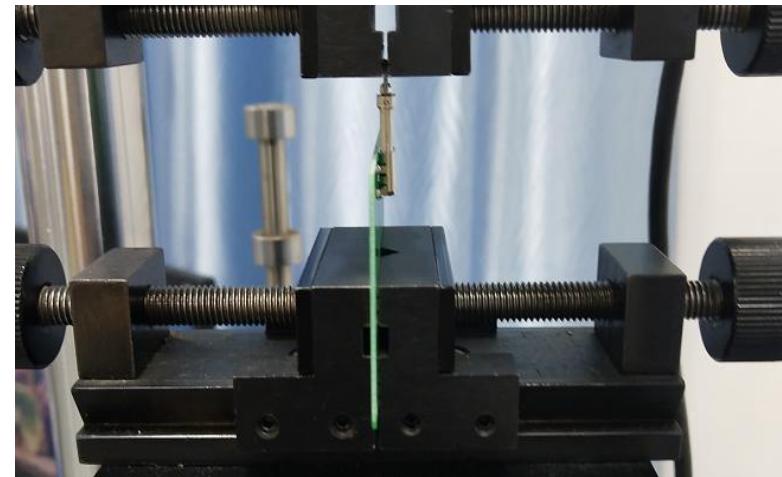
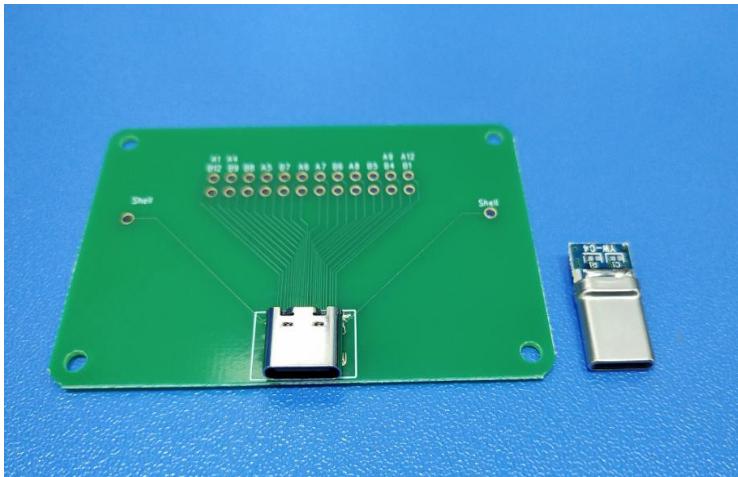
Test By: 韦凤

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测试项目 Test Item	<input type="checkbox"/> 接触阻抗 LLCR	<input type="checkbox"/> 耐电压 DWV	<input type="checkbox"/> 冷热冲击 Thermal Shock	<input type="checkbox"/> 盐水喷雾 Salt Spray	<input checked="" type="checkbox"/> 耐久性测试 Durability	<input checked="" type="checkbox"/> 插拔力 Mating force&Unmating force
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测试前准备



插拔力测试参数设置



耐久测试参数设置



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Checked By: /

Test By: 韦凤